

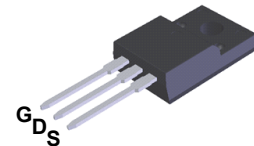
H7N65D

7A N-Channel Power MOSFET

Features

- New technology for high voltage device
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

TO-220F



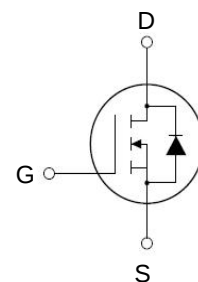
Mechanical Data

Case : Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : As marked

Mounting Position : Any



Schematic diagram

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Table 1. Absolute Maximum Ratings (T_c=25°C)

Parameter	Symbol	H7N65D	Unit
Drain-Source Voltage (V _{GS} =0V)	V _{DS}	650	V
Gate-Source Voltage (V _{DS} =0V) AC (f>1 Hz)	V _{GS}	±30	V
Continuous Drain Current at T _c =25°C	I _D (DC)	7	A
Continuous Drain Current at T _c =100°C	I _D (DC)	3.2	A
Pulsed drain current ^(Note 1)	I _{DM} (pluse)	28	A
Maximum Power Dissipation (T _c =25°C)	P _D	40	W
Single pulse avalanche energy ^(Note 2)	E _{AS}	230	mJ
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55...+150	°C

Table 2. Thermal Characteristic

Parameter	Symbol	TYPE	Unit
Thermal Resistance, Junction-to-Case	R_{thJC}	3.13	$^{\circ}\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62.5	$^{\circ}\text{C}/\text{W}$

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =650V, V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =520V, V _{GS} =0V			10	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2		4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =3.5A		1200	1400	mΩ
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =50V, V _{GS} =0V, F=1.0MHz		435		pF
Output Capacitance	C _{oss}			28		pF
Reverse Transfer Capacitance	C _{rss}			3.3		pF
Total Gate Charge	Q _g	V _{DS} =480V, I _D =7A, V _{GS} =10V		11		nC
Gate-Source Charge	Q _{gs}			3.5		nC
Gate-Drain Charge	Q _{gd}			5		nC
Switching times						
Turn-on Delay Time	t _{d(on)}	V _{DD} =380V, I _D =3.5A, R _G =4.7Ω, V _{GS} =10V		8		nS
Turn-on Rise Time	t _r			7		nS
Turn-Off Delay Time	t _{d(off)}			58	75	nS
Turn-Off Fall Time	t _f			9	15	nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T _C =25℃			7	A
Pulsed Source-drain current(Body Diode)	I _{SDM}				28	A
Forward On Voltage	V _{SD}	T _j =25℃, I _{SD} =7A, V _{GS} =0V		0.9	1.3	V
Reverse Recovery Time	t _{rr}	T _j =25℃, I _F =3.5A, di/dt=100A/μs		210		nS
Reverse Recovery Charge	Q _{rr}			0.85		uC
Peak Reverse Recovery Current	I _{rrm}			8		A

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. $T_j=25^{\circ}\text{C}, V_{DD}=50V, V_G=10V, R_G=25\Omega$

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area

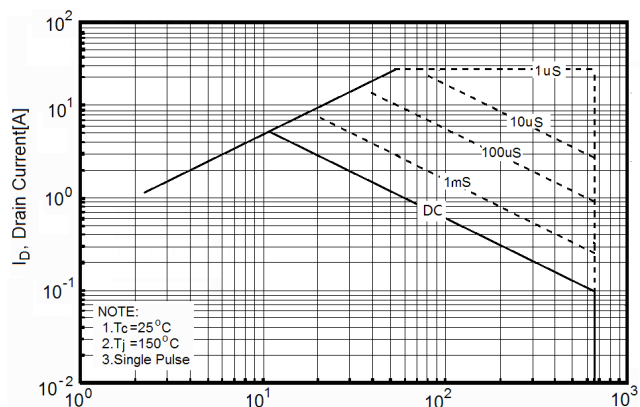


Figure2. Source-Drain Diode Forward Voltage

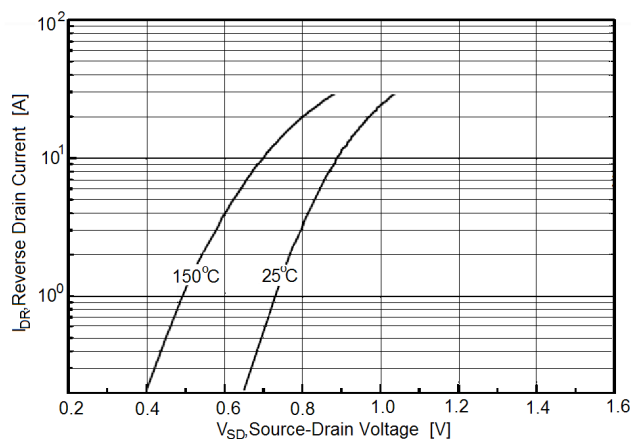


Figure3. Output characteristics

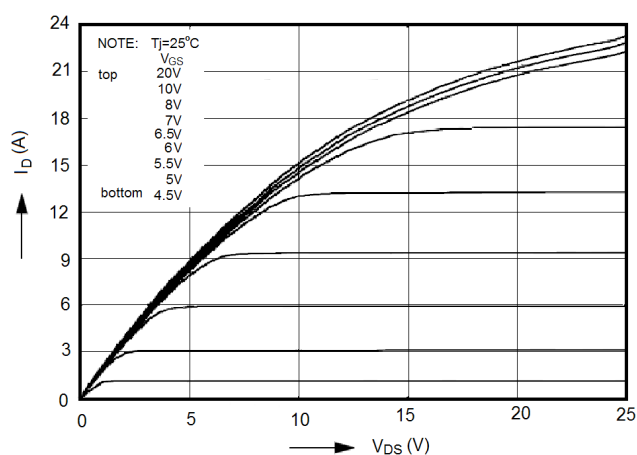


Figure4. Transfer characteristics

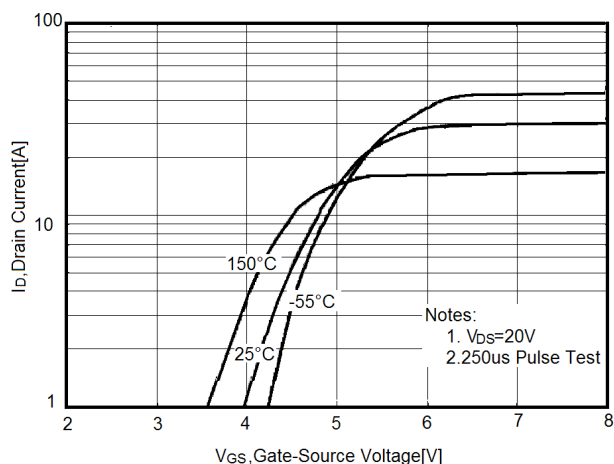


Figure5. Static drain-source on resistance

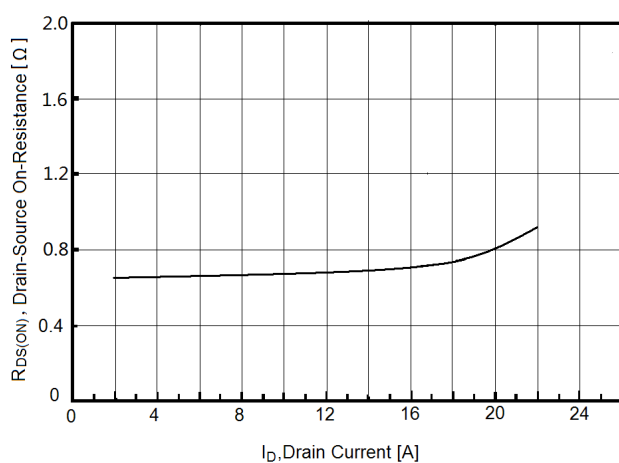


Figure6. $R_{DS(ON)}$ vs Junction Temperature

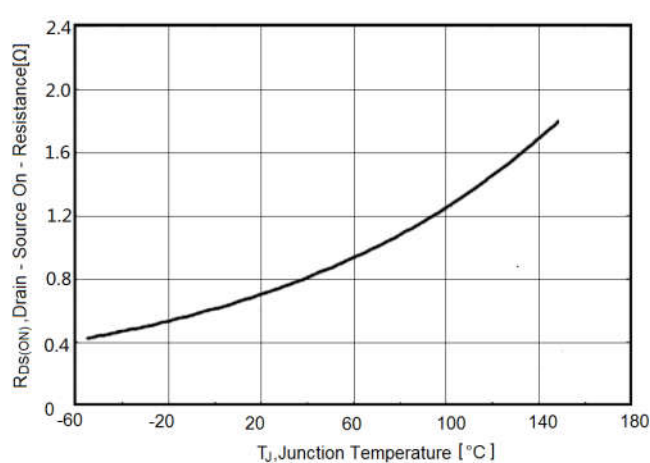
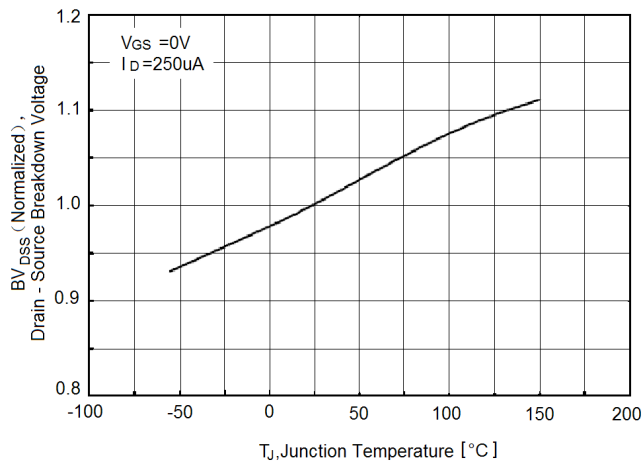
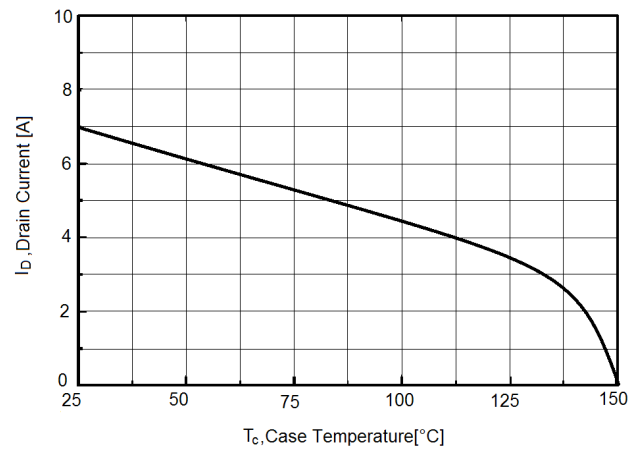
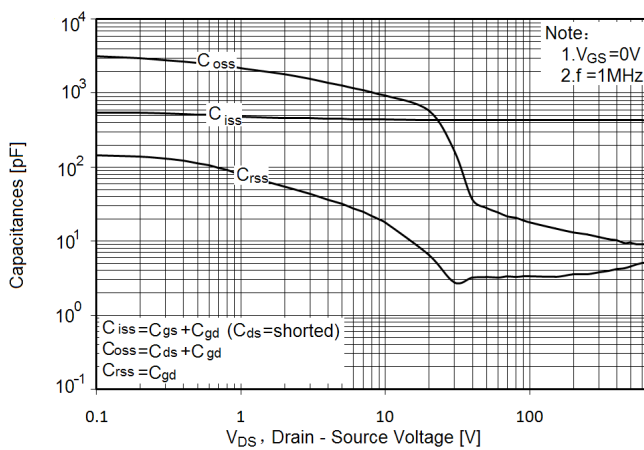
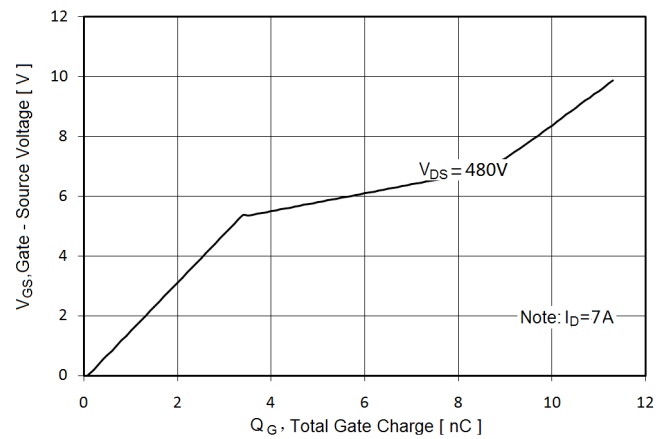
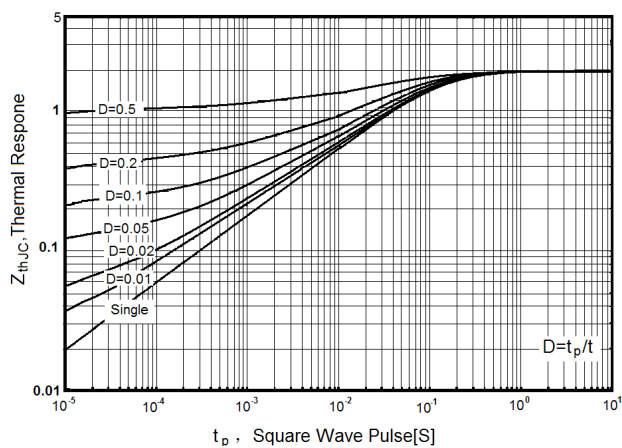
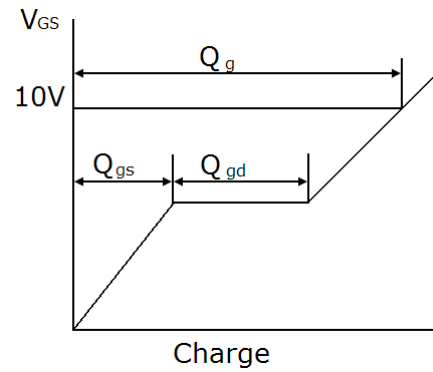
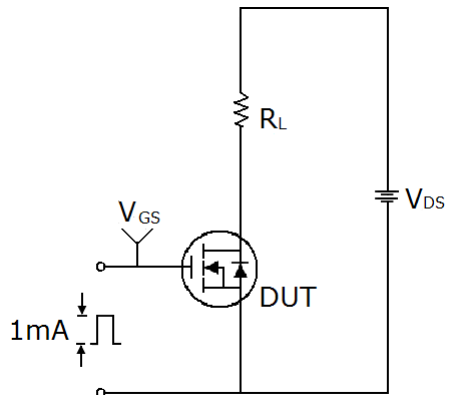


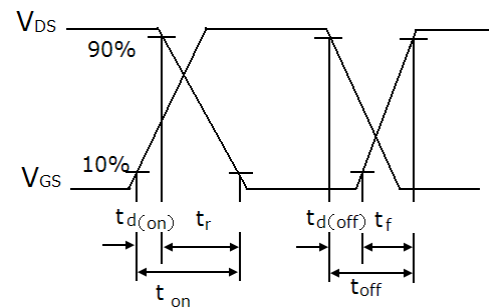
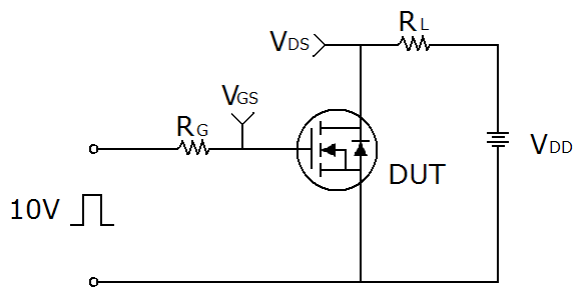
Figure7. BV_{DSS} vs Junction Temperature

Figure8. Maximum I_D vs Junction Temperature

Figure9. Capacitance

Figure10. Gate charge waveforms

Figure11. Transient Thermal Impedance


Test circuit

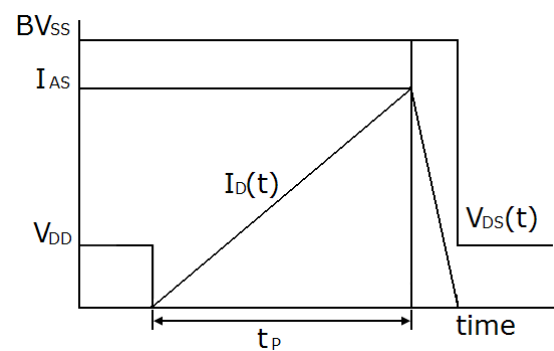
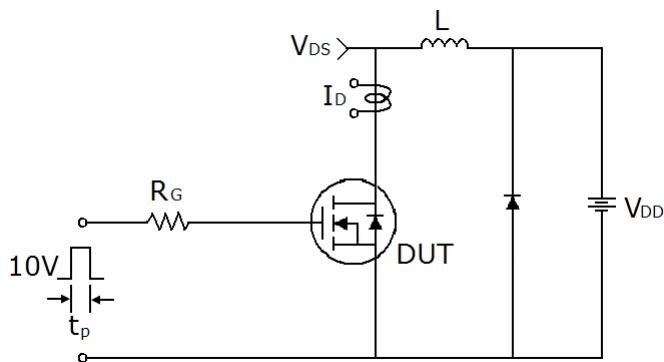
1) Gate charge test circuit & Waveform



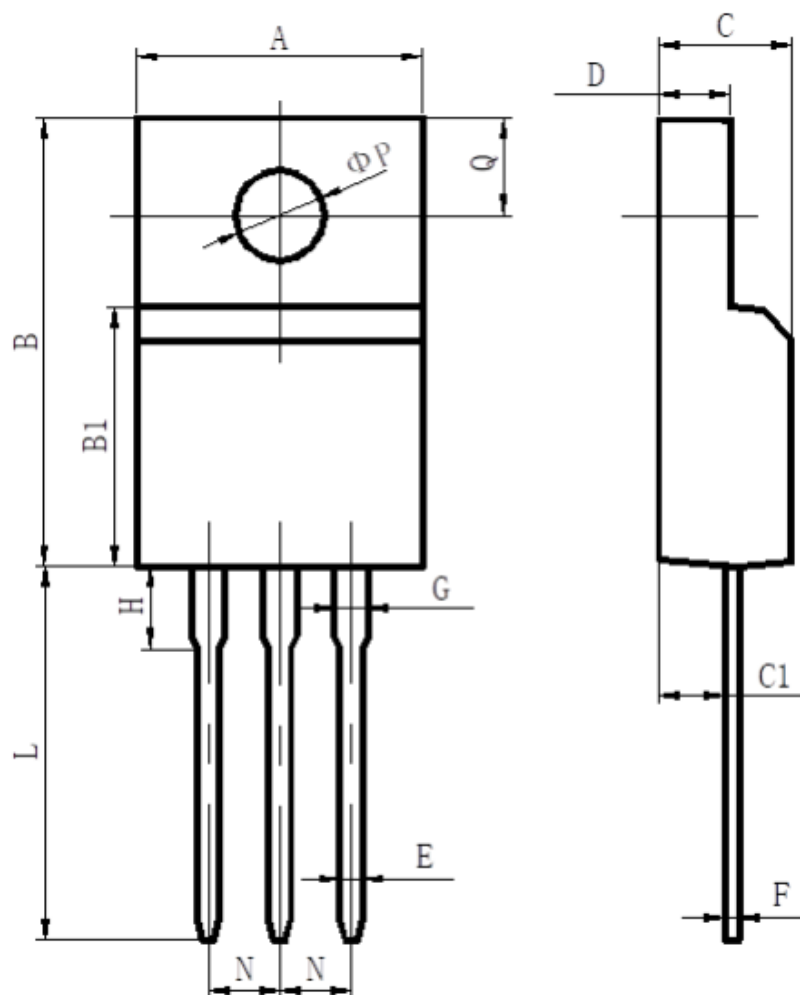
2) Switch Time Test Circuit:



3) Unclamped Inductive Switching Test Circuit & Waveforms



TO-220F Package Outline Dimensions



Symbol	Dimensions in Millimeters	
	MIN	MAX
A	9.70	10.30
B	15.50	16.10
B1	8.99	9.39
C	4.40	4.80
C1	2.15	2.55
D	2.50	2.90
E	0.70	0.90
F	0.40	0.60
G	1.12	1.42
H	3.40	3.80
L	12.6	13.6
N	2.34	2.74
Q	3.15	3.55
ΦP	3.00	3.30